

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Yi-Chieh Lin	06/29/2011
Yu-Hsin Chen	06/29/2011
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
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Total Attachments: 2 source=005#page1.tif source=005#page2.tif	

CH \$40.00 13175891

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title)

WIRELESS TRANSCEIVER APPARATUS HAVING CIRCUIT UNIT FORMING
FREQUENCY RESONANCE MODE WHEN OPERATED UNDER RECEPTION MODE

The PATENT RIGHTS referred to in this agreement are:

(check one) a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.

U.S. patent application Serial No. _____, filed _____

a U.S. patent application based on PCT International Application No. _____, filed on (date) _____ (U.S. patent application Serial No. _____, if known)

U.S. Patent No. _____, issued _____

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) U.S. patent rights only.

Worldwide patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signature(s) appear(s) on page 2 of this Assignment and any Supplemental Sheets(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) Realtek Semiconductor Corp.

(Address) 2 Innovation Rd. II, Science Park, HsinChu 30076, Taiwan, R.O.C.

The ASSIGNEE is:

(check one) An Individual.

A Partnership.

A Corporation of Taiwan, R.O.C. (specify state or country)

(other) _____

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;
the entire right, title and interest in and to the PATENT RIGHTS;
the right to sue and recover for any past infringement; and,
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) any attorney and agent who has a power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

JUN 29 2011

YI-CHIEH LIN	<i>YI CHIEH LIN</i>	
First joint inventor	Signature	Date
YU-HSIN CHEN	<i>Yu Hsin Chen</i>	JUN 29 2011
Second joint inventor	Signature	Date
Third joint inventor	Signature	Date
Fourth joint inventor	Signature	Date
Fifth joint inventor	Signature	Date